

Meeting Minutes SCC18 Adhoc
July 18, 2018
1PM ET

13:02 Meeting called to order.

Adhoc Chair reviewed agenda slides, covered the IEEE patent policy and participation rules.

13:04 Chair informs the group that minutes for the previous meeting are posted, asked if anyone that wanted to review the minutes hadn't had the chance to review, and asked if there were any changes to be made to the minutes. Chair instructs the webmaster to change the status of the 7/11/18 minutes to approved.

13:05 Meeting moved to main agenda. The group reviewed http://www.ieee802.org/3/ad_hoc/SCC_18/public/TC716_and_NEC_SR_comments.pdf. Notes were taken in the reviewed document and a 071818 version will be posted.

Other relevant upcoming date/meetings:

NFPA Public Comment Deadline: Aug 30, 2018

PT716 comment due date: Sept 14, 2018

2020 NEC Second Draft Meeting October 22-November 3, 2018 San Diego, CA

The next scheduled SCC18 adhoc meeting is July 25, 2018, 1PM ET.

14:03: Having exhausted time, the meeting was adjourned.

Attendance:

Name	Employer; Affiliation	Present
Arkadiy Peker	Microsemi; Microsemi	*
Chad Jones	Cisco; Cisco	*
David Law	HPE; HPE	*
David Tremblay	HPE; HPE	*
Fred Dawson	Chemours; Chemours	*
Geoff Thompson	Unemployed; Unaffiliated	*
George Zimmerman	CME; APL, BMW, Cisco, Commscope, LTC/ADI	*
Andrew Jimenez	Anixter; Anixter	
Bill Szeto	Retired; Unaffiliated	
Borhan Fathi	Nvidia; Nvidia	
Chris DiMinico	MC Communications; Panduit	
Craig Chabot	UNH-IOL; UNH-IOL	
Curtis Donahue	UNH-IOL; UNH-IOL	
Ernie Gallo	Ericsson; Ericsson	
James Withey	Fluke; Fluke	
Jeff Lapak	UNH-IOL; UNH-IOL	
Jennifer Santalli	STAFF	

Jim Brunssen	Eriasson; Ericsson	
Joel Goergen	Cisco; Cisco	
John Fuller	AT&T; AT&T	
Jonathan Goldberg	STAFF	
Ken Bennett	Sifos; Sifos	
Masood Shariff	Commscope; Commscope	
Matthew Ceglia	STAFF	
Mike Anthony	StandardsMichigan, LLC, StandardsMichigan, LLC	
Miklos Lucas	Silicon Labs; Silicon Labs	
Pat Roder	STAFF	
Paul Nikolich	Independent	
Paul Vanderlaan	Berk-Tek LLC; Berk-Tek LLC	
Rick Voss	Panduit; Panduit	
Ron Tellas	Belden, Belden	
Sesha Panguluri	Broadcom; Broadcom	
Shiyong Fu	Huawei; Huawei	
Steve Carlson	High Speed Design, Inc.; High Speed Design, Inc.	
Valerie Maquire	Siemon; Siemon	
Yair Darshan	Microsemi; Microsemi	